



SK32B THRU SK310B

SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

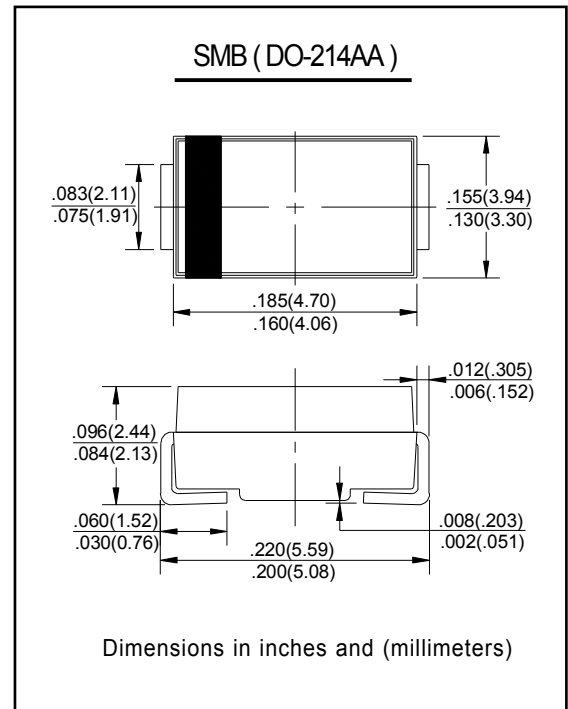
Reverse Voltage - 20 to 100 Volts Forward Current - 3.0 Ampere

FEATURES

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Metal silicon junction, majority carrier conduction
- Low reverse leakage
- Built-in strain relief, ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed:
250°C/10 seconds at terminals

MECHANICAL DATA

Case: JEDEC SMB(DO-214AA) molded plastic body
Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
Polarity: Color band denotes cathode end
Mounting Position: Any
Weight: 0.005 ounce, 0.138 grams



Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

Characteristic	Symbol	SK32B	SK33B	SK34B	SK35B	SK36B	SK38B	SK39B	SK310B	Unit	
Peak Repetitive Reverse Voltage	V _{RRM}										
Working Peak Reverse Voltage	V _{RWM}	20	30	40	50	60	80	90	100	V	
DC Blocking Voltage	V _R										
RMS Reverse Voltage	V _{R(RMS)}	14	21	28	35	42	56	64	71	V	
Average Rectified Output Current @T _L = 75°C	I _O	3.0								A	
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	70								A	
Forward Voltage @I _F = 3.0A	V _{FM}	0.50			0.70		0.85			V	
Peak Reverse Current @T _A = 25°C At Rated DC Blocking Voltage @T _A = 100°C	I _{RM}						0.5 10				mA
Typical Thermal Resistance (Note 1)	R _{θJL} R _{θJA}						17 75				°C/W
Operating Temperature Range	T _j	-65 to +125								°C	
Storage Temperature Range	T _{STG}	-65 to +150								°C	

Note: 1. Mounted on P.C. Board with 5.0mm² copper pad area.



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RATINGS AND CHARACTERISTIC CURVES

FIG. 1- MAXIMUM FORWARD CURRENT DERATING CURVE

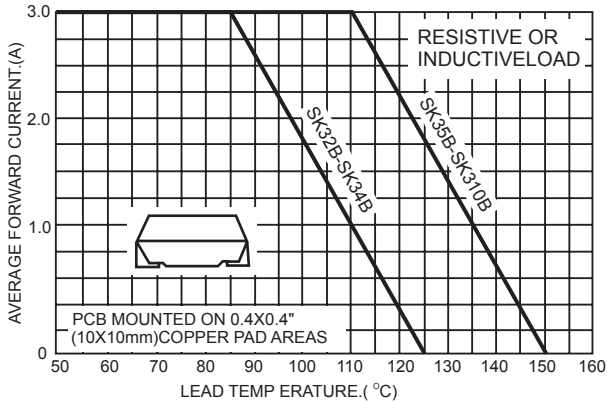


FIG. 2- MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

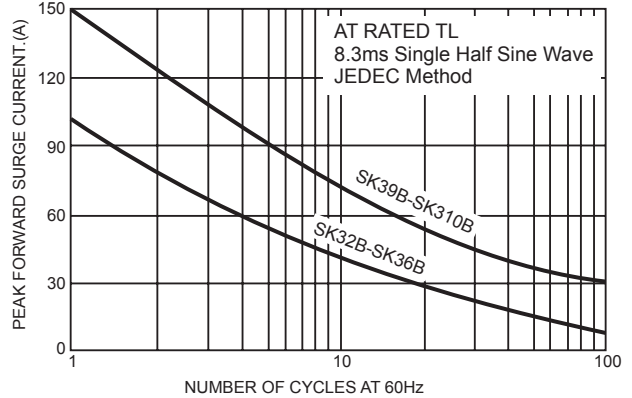


FIG. 3- TYPICAL FORWARD CHARACTERISTICS

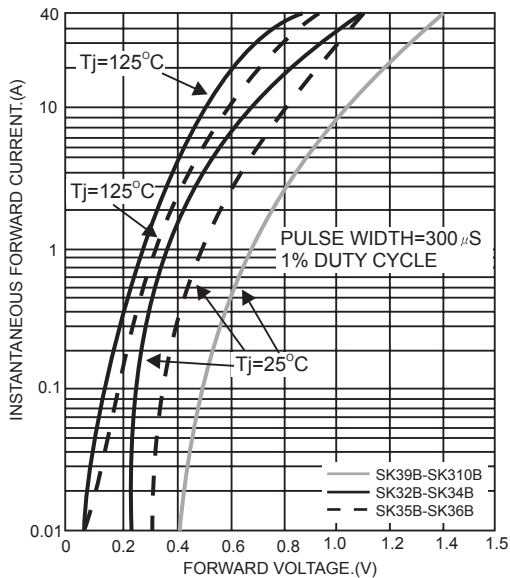


FIG. 4- TYPICAL REVERSE CHARACTERISTICS

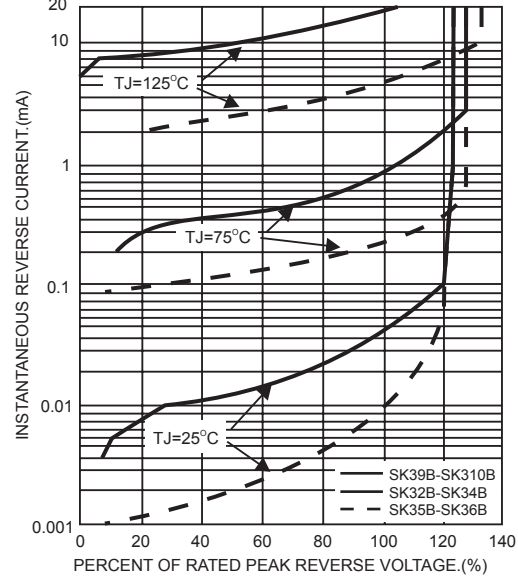


FIG. 5- TYPICAL JUNCTION CAPACITANCE

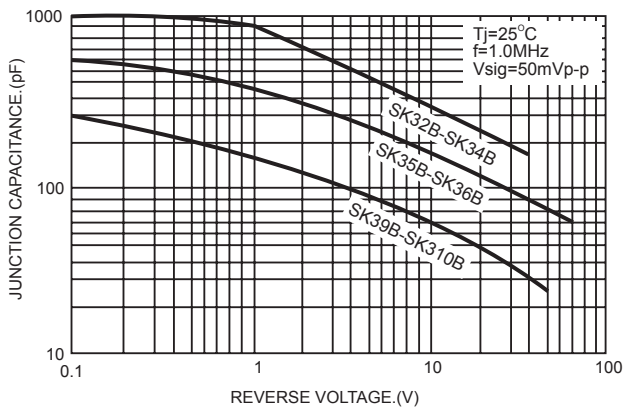


FIG. 6- TYPICAL TRANSIENT THERMAL CHARACTERISTICS

